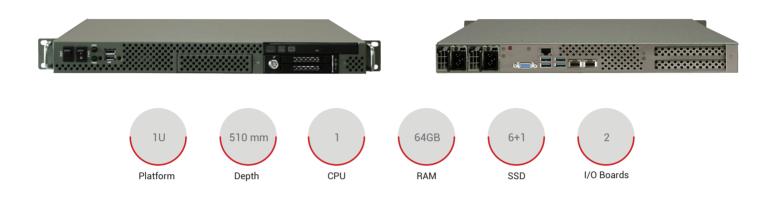
GAP-151R - G6 Series 1U RUGGED WORKSTATION



Intel[®] Xeon[®] E3-1200 v5/v6, Intel[®] 6th/7th Gen. Core[™] i7/i5/i3 series - Kaby Lake / Sky Lake Rear I/O - Rear Power Supply



GAP is a line of rugged servers and workstations with aluminum construction, designed for applications that require a robust and qualified MIL-GRADE device, suitable for operating in critical environments.

GAP-151R G6 series workstations feature single socket Intel[®] Xeon[®] E3-1200 v5/v6, Intel[®] 6th/7th Gen. Core[™] i7/ i5/i3 series (Kaby Lake / Sky Lake) processors supporting up to 4 Cores (8 thread with Hyper-Threading), 8MB Smart Cache, up to 64GB DDR4 memory with or without ECC and up to 16 PCIe 3.0 lanes. The integrated IPMI services support monitoring, control, and management functions and provides for alarm notifications in case of critical events.

GAP-151R is designed for 19" rackmounting and has a 1U chassis with 510mm depth.

The rear I/O and rear power supply layout includes three removable SSD, an internal SSD and an optional slim DVD. GAP-151R rugged workstation can host up to two PCIe cards.

The additional boards are equipped with dedicated fixing systems to ensure optimal operation even in the presence of shock and vibration or during transport.

GAP workstations are qualified according to MIL-STD-810G for temperature, shock and vibration and can optionally conform to MIL-STD-461 for EMI /EMC. Upon request, the integrated devices, complete with I / O cards, can be subjected to specific profiles of thermal or mechanical stress. Versions with MIL grade connectors on I/O ports and power input are available. All units are delivered with their inventory list to ensure configuration control and reproducibility over time.

FEATURES

- 1U Rugged Workstation 510mm depth
- Single Intel[®] Xeon[®] E3-1200 v5/v6 series
- Single Intel[®] 6th/7th Gen. Core[™] i7/i5/i3 series
- Rear I/O connectors
- · Rear Power Input
- Redundant AC or DC Power Supply
- Up to 6 x removable 2.5" SSD + 1 x internal 2.5" SSD
- Optional DVD
- Up to 2 PCIe boards
- Optional Conformal Coating
- MIL-STD-810G
- Optional MIL-STD-461



Technical Specifications

Vibrations

Operative Shock

Transport shock

Certifications

Processor	Intel® Xeon® E3-1200 v5/v6, Intel® 6th/7th Gen. Core™ i3 (up to 80W TDP) - single socket H4 (LGA 1151)
Memory	Up to 64GB ECC UDIMM, DDR4-2400MHz
Chipset	Intel [®] C236
Network	2 x RJ45 Gigabit Ethernet 1 x RJ45 dedicated IPMI
Storage	2.5" SATA Disk - RAID 0, 1, 5, 10
SATA	6 SATA3 ports (6Gbps); RAID 0, 1, 5, 10
ТРМ	1 TPM Header
Motherboard I/O	Available on the rear: 1 x VGA, 2 x USB 2.0, 2 x USB 3.0, 1 x COM, 2 x LAN, 1 x IPMI
Expansion slots	2x PCIe - Bracket Full Height
Operative Systems	Windows [®] 7, Windows [®] 8.1, Windows [®] 10 IoT Enterprise 2016, Windows [®] Server 2008 R2, Windows [®] Server 2012 R2, Hyper-V Server 2012 R2, Linux
IPMI	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications
Monitoring	Monitoring, control, and management functions (fan speed, temperature, voltage, redundant power failure, power consumption disk health, raid health, and memory health)
Power Supply	
Power Supply	100/240 Single or Redundant VAC 18-36 Single or Redundant VDC 36-72 Single or Redundant VDC
Mechanical	
Dimensions	483 x 44,45 x 510 mm from angle 19" - 540 mm full depth
Construction	Aluminum with surface passivation treatment
Colour	Silver
Mounting	1U 19" rackmount chassis Telescopic slides optional
Configuration	Rear I/O and Power Supply
Front Panel	Led: Led Power ON and HDD/SSD functionality; Switch: Power ON / OFF and System Reset; Connectors: 2 x USB 2.0
Drive Bay	1 x slim 5.25"; 2 x 3.5" bay + 1 x internal ODD 2.5"
Environmental - (Design t	to meet)
Operative Temperature	Standard: 0°C / +50°C Extended: -20°C / +60°C (depending on the configurations)
Operative Humidity	8% to 95% non-condensed (depending on the configurations)
Storage Temperature	-40°C / +70°C

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.

Directive 2014/35/UE-LVD / Directive 2014/30/UE-EMC Directive 2011/65/UE - RoHS / Regulation (EC) No 1907/2006 - REACH

MIL-STD-810G Proc. I Method 516.7 - 15g / 11ms - half sine

MIL-STD-810G Proc. II Method 516.7 - 30g / 9ms sawtooth

MIL-STD-810G, Method 514.7, Cat 4 - Proc. I - 2.24 Grms, 5-500 Hz 60 min/axis for 3 axes